

ZXTC2061E6

12V COMPLEMENTARY MEDIUM POWER TRANSISTOR IN SOT26

Features

- NPN + PNP Combination
- BV_{CEO} > 12 (-12)V
- BV_{EBO} > 7 (-7)V
- Continuous Collector Current $I_{C} = 5$ (-3.5)A
- V_{CE(sat)} < 32 (-70)mV @ 1A
- $R_{CE(sat)} = 25 (45) m\Omega$
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Description

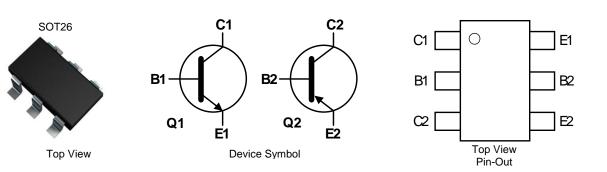
Advanced process capability has been used to achieve this high performance device. Combining NPN and PNP transistors in the SOT26 package provides a compact solution for the intended applications.

Mechanical Data

- Case: SOT26
- Case Material: Molded Plastic, "Green" Molding Compound; UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.015 grams (Approximate)

Applications

- MOSFET and IGBT Gate Driving
- Motor Drive



Ordering Information (Note 4)

Product	Complianace	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel	
ZXTC2061E6TA	AEC-Q101	2061	7	8	3,000	
Notes: 1. No purposelv added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.						

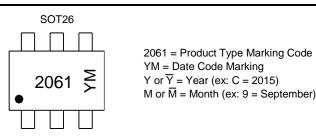
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



Date Code	Key												
Year	201	5 2	2016	2017	2018	2019	2020	202	1 20	22 2	2023	2024	2025
Code	С		D	E	F	G	Н	-		J	K	L	М
Month	1 I	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	2	1	2	3	4	5	6	7	8	9	0	N	D



Absolute Maximum Ratings – Q1 (NPN Transistor) (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	20	V
Collector-Emitter Voltage	V _{CEO}	12	V
Emitter-Base Voltage	V _{EBO}	7	V
Continuous Collector Current	lc	5	A
Peak Pulsed Collector Current	I _{CM}	12	A
Base Current	IB	1	A

Absolute Maximum Ratings – Q2 (PNP Transistor) (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	-12	V
Collector-Emitter Voltage	V _{CEO}	-12	V
Emitter-Base Voltage	V _{EBO}	-7	V
Continuous Collector Current	lc	-3.5	A
Peak Pulsed Collector Current	I _{CM}	-10	A
Base Current	Ι _Β	-1	А

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
	(Notes 5 & 9)		0.7 5.6		
	(Notes 6 & 9)		0.9 7.2		
Power Dissipation Linear Derating Factor	(Notes 6 & 10)	PD	1.1 8.8	W mW/°C	
Ŭ	(Notes 7 & 9)		1.1 8.8		
	(Notes 8 & 9)		1.7 13.6		
	(Notes 5 & 9)		179		
	(Notes 6 & 9)		139		
Thermal Resistance, Junction to Ambient	(Notes 6 & 10)	R _{0JA}	113		
	(Notes 7 & 9)		113	°C/W	
	(Notes 8 & 9)		73		
Thermal Resistance, Junction to Lead	(Note 11)	R _{0JL}	87.58		
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C		

ESD Ratings (Note 12)

Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge - Machine Model	ESD MM	400	V	С

Notes: 5. For a device surface mounted on 15mm x 15mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions; the device is measured when operating in a steady-state condition. 6. Same as Note 5, except the device is surface mounted on 25mm x 25mm 1oz copper. 7. Same as Note 5, except the device is surface mounted on 50mm x 50mm 2oz copper.

8. Same as Note 7, except the device is measured at t < 5 seconds.

9. For device with one active die, both collectors attached to a common heatsink.

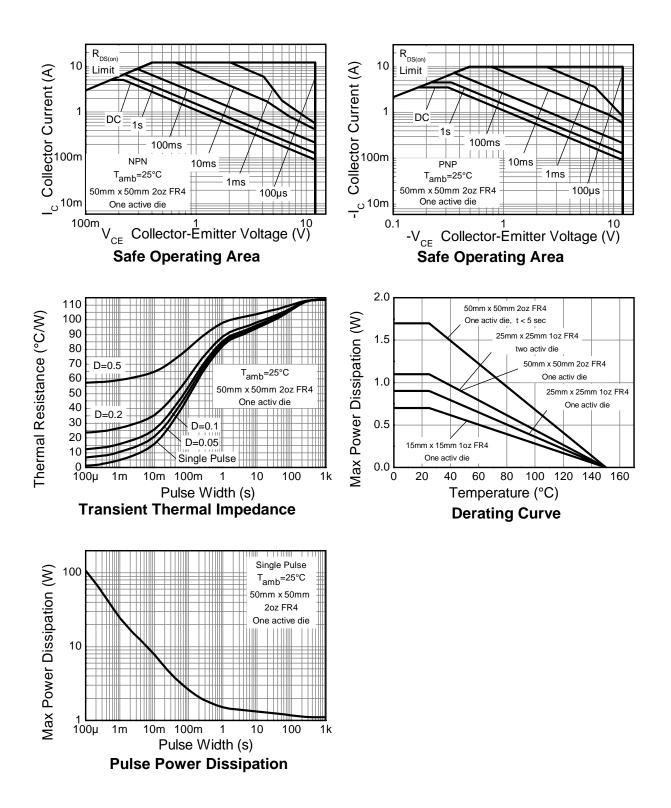
10. For device with two active dice running at equal power, split heatsink 50% to each collector.

11. Thermal resistance from junction to solder-point (at the end of the collector lead).

12. Refer to JEDEC specification JESD22-A114 and JESD22-A115.



Thermal Characteristics and Derating Information





Electrical Characteristics – Q1 (NPN Transistor) (@T_A = +25°C, unless otherwise specified.)

	I I		1	1	I	
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS						
Collector-Base Breakdown Voltage	BV CBO	20	40	—	V	$I_{C} = 100 \mu A, I_{E} = 0$
Collector-Emitter Breakdown Voltage (Note 13)	BV _{CEO}	12	17		V	$I_{\rm C} = 10 {\rm mA}, I_{\rm B} = 0$
Emitter-Base Breakdown Voltage	BV _{EBO}	7	8.4	—	V	$I_{E} = 100 \mu A, I_{C} = 0$
Collector Cut-Off Current	I _{CBO}	_	<1	50 0.5	nA µA	V _{CB} = 20V V _{CB} = 20V, T _A = +100°C
Collector Cut-Off Current	IEBO	_	<1	50	nA	$V_{\text{EB}} = 5.6 \text{V}$
ON CHARACTERISTICS (Note 13)			1	1		
DC Current Gain	h _{FE}	500 480 260	800 750 390	1,500	_	$ I_{C} = 10 mA, V_{CE} = 2V \\ I_{C} = 1.0A, V_{CE} = 2V \\ I_{C} = 5A, V_{CE} = 2V $
Collector-Emitter Saturation Voltage	V _{CE(sat)}	_	32 50 65 145	40 60 80 180	mV	$I_{C} = 1.0A, I_{B} = 100mA$ $I_{C} = 1.0A, I_{B} = 10mA$ $I_{C} = 2.0A, I_{B} = 40mA$ $I_{C} = 5A, I_{B} = 100mA$
Base-Emitter Saturation Voltage	V _{BE(sat)}		920	1,000	mV	$I_{\rm C} = 5$ A, $I_{\rm B} = 100$ mA
Base-Emitter Turn-On Voltage	V _{BE(on)}		810	900	mV	$I_C = 5A, V_{CE} = 2V$
SMALL SIGNAL CHARACTERISTICS						·
Output Capacitance	Cobo		26	35	pF	V _{CB} = 10V, f = 1.0MHz
Current Gain-Bandwidth Product	f⊤		260		MHz	V _{CE} = 10V, I _C = 50mA, f = 100MHz
Delay Time	t _d		71		ns	
Rise Time	t _r — 70 — ns					
Storage Time	ts	—	233		ns	$V_{CC} = 10V, I_C = 1A, I_{B1} = -I_{B2} = 10mA$
Fall Time	tf	_	72	_	ns	

Electrical Characteristics – Q2 (PNP Transistor) (@T_A = +25°C, unless otherwise specified.)

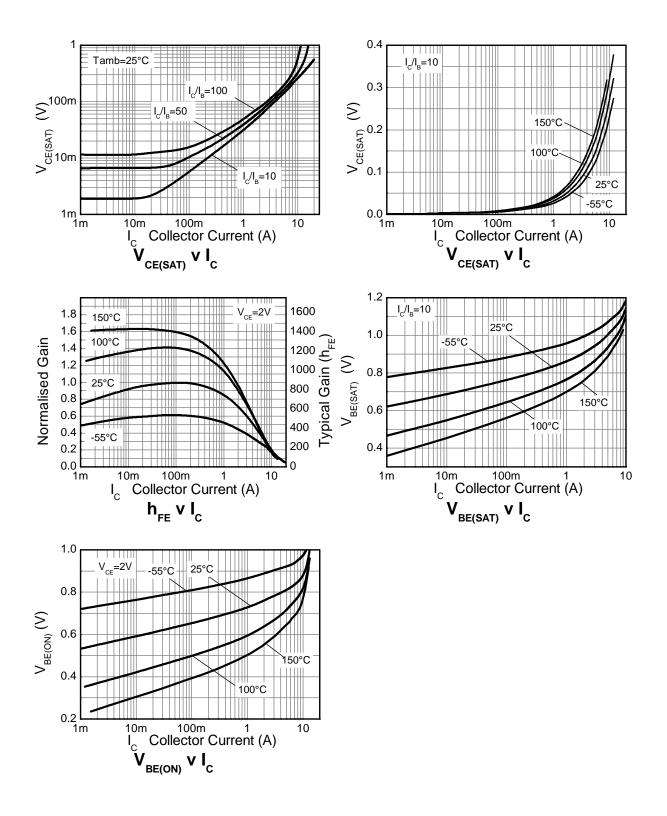
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS						
Collector-Base Breakdown Voltage	BVCBO	-12	-35	_	V	$I_{C} = -100 \mu A, I_{E} = 0$
Collector-Emitter Breakdown Voltage (Note 13)	BVCEO	-12	-25	_	V	$I_{\rm C} = -10 {\rm mA}, I_{\rm B} = 0$
Emitter-Base Breakdown Voltage	BV _{EBO}	-7	-8.4	_	V	$I_{\rm E} = -100 \mu A, I_{\rm C} = 0$
Collector Cut-Off Current	1	_	< -1	-50	nA	V _{CB} = -12V
	I _{CBO}	_		-0.5	μA	$V_{CB} = -12V, T_A = +100^{\circ}C$
Collector Cut-Off Current	I _{EBO}	_	< -1	-50	nA	V _{EB} = -5.6V
ON CHARACTERISTICS (Note 13)						
		500	800	1500		$I_{C} = -10 \text{mA}, V_{CE} = -2 \text{V}$
DC Current Gain	h _{FE}	290	450	—	—	I _C = -1.0A, V _{CE} = -2V
		75	100	—		$I_{C} = -3.5A, V_{CE} = -2V$
		_	-55	-70		I _C = -1.0A, I _B = -100mA
Collector-Emitter Saturation Voltage	V _{CE(sat)}	_	-170	-265	mV	$I_{\rm C} = -1.0$ A, $I_{\rm B} = -10$ mA
Concoror Emilior Caldration Voltage	VCE(sat)	—	-220	-360		$I_{\rm C} = -2.0$ A, $I_{\rm B} = -40$ mA
			-150	-200		I _C = -3.5A, I _B = -350mA
Base-Emitter Saturation Voltage	V _{BE(sat)}	—	-955	-1,050	mV	I _C = -3.5A, I _B = -350mA
Base-Emitter Turn-On Voltage	V _{BE(on)}	_	-830	-900	mV	I _C = -3.5A, V _{CE} = -2V
SMALL SIGNAL CHARACTERISTICS						
Output Capacitance	Cobo	_	17	25	pF	V _{CB} = -10V, f = 1.0MHz
Current Gain-Bandwidth Product	f⊤		310		MHz	V _{CE} = -10V, I _C = -50mA, f = 100MHz
Delay Time	t _d	_	41	_	ns	
Rise Time	tr	—	62	—	ns	$V_{CC} = -10V, I_C = -1A,$
Storage Time	t _s	_	179	—	ns	$I_{B1} = -I_{B2} = -10 \text{mA}$
Fall Time	t _f	_	65	_	ns	

Note: 13. Measured under pulsed conditions. Pulse width \leq 300µs. Duty cycle \leq 2%.



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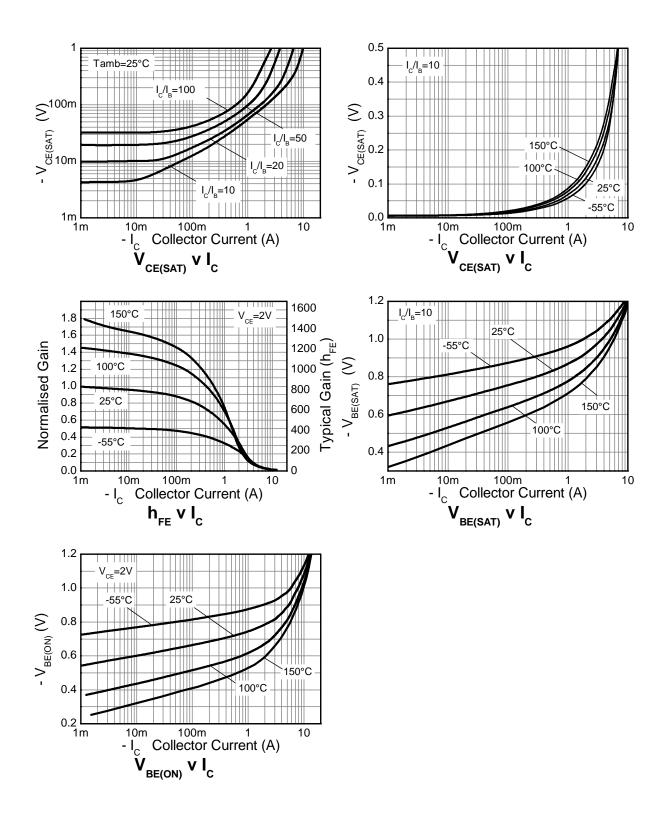
Typical Electrical Characteristics – Q1 (NPN Transistor) (@T_A = +25°C, unless otherwise specified.)





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Typical Electrical Characteristics – Q2 (PNP Transistor) (@T_A = +25°C, unless otherwise specified.)





Тур

0.05

1.10

0.75

0.38

0.15

3.00

0.95

1.90

2.80

1.60

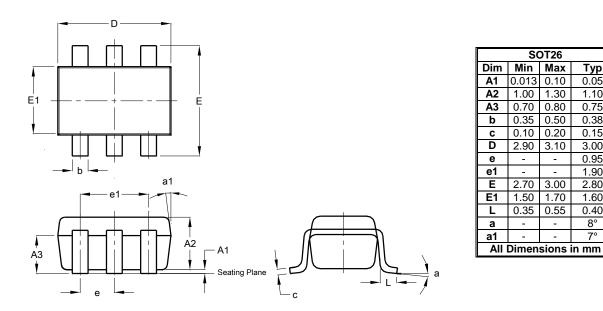
0.40

8°

7°

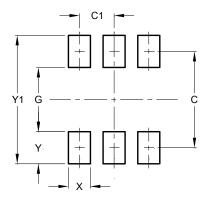
Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	2.40
C1	0.95
G	1.60
Х	0.55
Y	0.80
Y1	3.20



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